# ne<mark>x</mark>peria

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Should be replaced with:

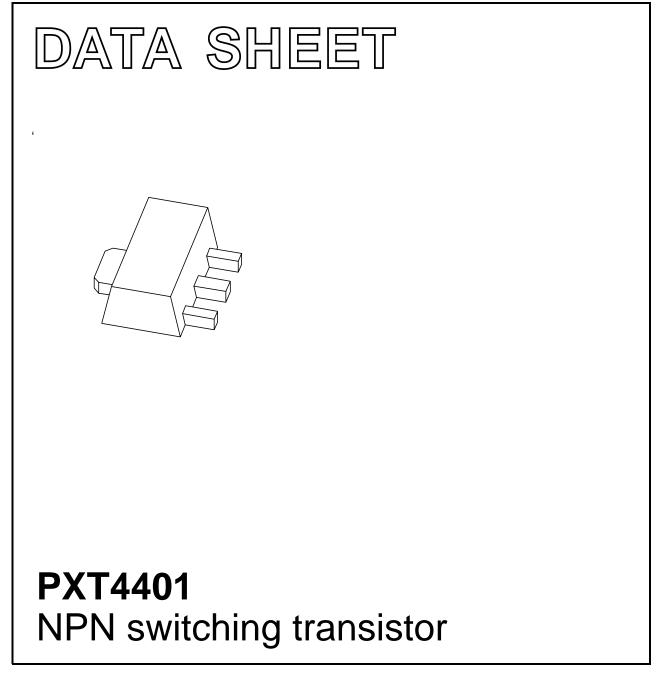
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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

# DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 1999 Apr 14 2004 Nov 22



#### Product data sheet

# NPN switching transistor

#### FEATURES

- High current (max. 600 mA)
- Low voltage (max. 40 V).

#### **APPLICATIONS**

• Switching and linear amplification in industrial and consumer applications.

#### DESCRIPTION

NPN switching transistor in a SOT89 plastic package. PNP complement: PXT4403.

#### MARKING

TYPE NUMBER	MARKING CODE <sup>(1)</sup>
PXT4401	*2X

#### Note

- 1. \* = p: Made in Hong Kong.
  - \* = t: Made in Malaysia.

\* = W: Made in China.

#### **ORDERING INFORMATION**

#### PINNING

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	

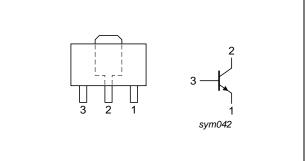


Fig.1 Simplified outline (SOT89) and symbol.

		PACKAGE		
ITFE NUMBER	NAME DESCRIPTION		VERSION	
PXT4401	SC-62	plastic surface mounted package; collector pad for good heat transfer; 3 leads	SOT89	

Downloaded from Arrow.com.

### PXT4401

### PXT4401

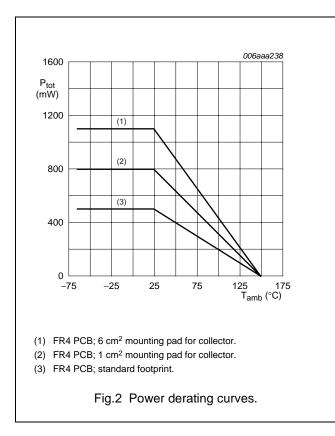
#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	-	60	V
V <sub>CEO</sub>	collector-emitter voltage	open base	—	40	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>C</sub>	collector current (DC)		—	600	mA
I <sub>CM</sub>	peak collector current		-	800	mA
I <sub>BM</sub>	peak base current		-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
		note 1	—	0.5	W
		note 2	—	0.8	W
		note 3	—	1.1	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C

#### Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm<sup>2</sup>.



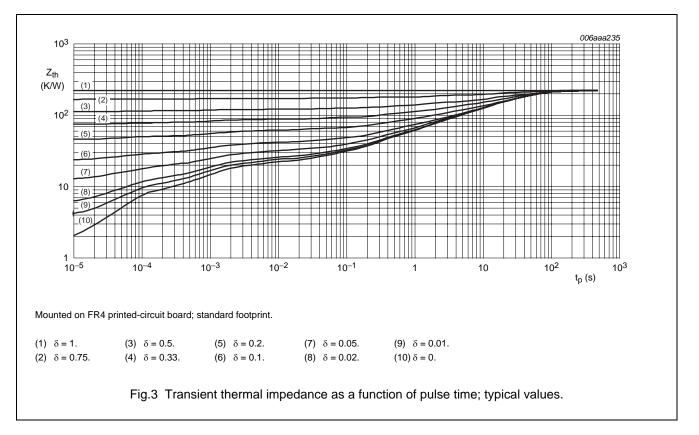
# PXT4401

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub> thermal resistance from jur ambient	thermal resistance from junction to	in free air		
	ambient	note 1	250	K/W
		note 2	156	K/W
		note 3	113	K/W
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point		30	K/W

#### Notes

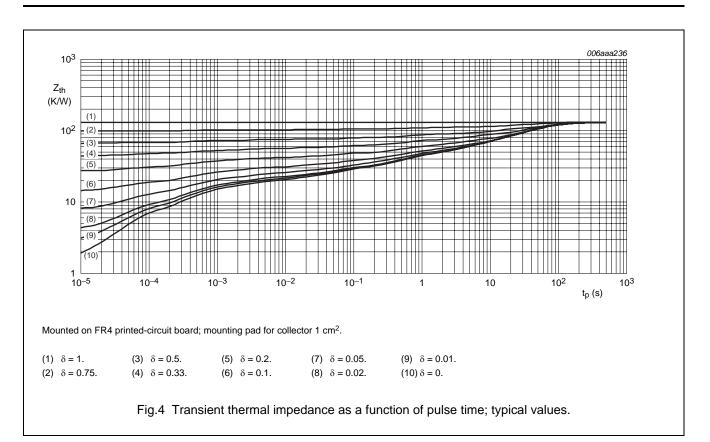
- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm<sup>2</sup>.

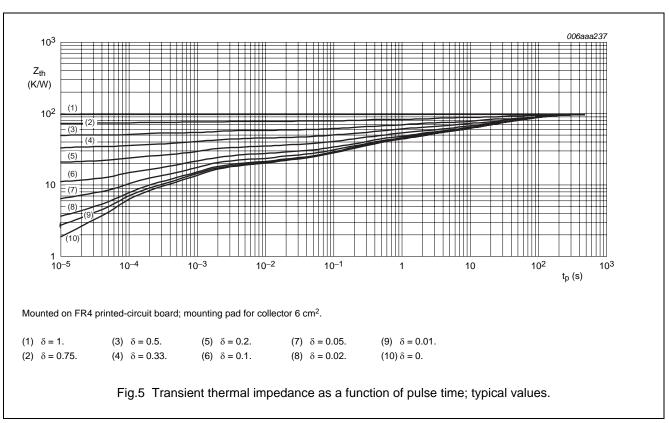


Product data sheet

# NPN switching transistor

# PXT4401





2004 Nov 22

# PXT4401

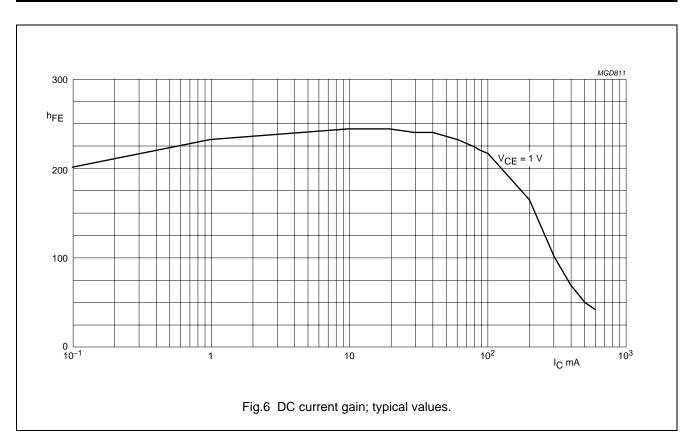
#### CHARACTERISTICS

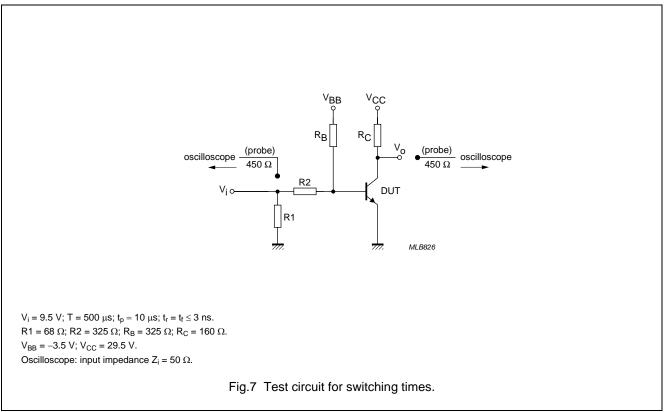
 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	I <sub>E</sub> = 0 A; V <sub>CB</sub> = 60 V	_	50	nA
I <sub>EBO</sub>	emitter-base cut-off current	I <sub>C</sub> = 0 A; V <sub>EB</sub> = 6 V	-	50	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 1 V; (see Fig.6)	20	-	
		I <sub>C</sub> = 0.1 mA	20	-	
		I <sub>C</sub> = 1 mA	40	-	
		I <sub>C</sub> = 10 mA	80	-	
		I <sub>C</sub> = 150 mA; note 1	100	300	
		I <sub>C</sub> = 500 mA; V <sub>CE</sub> = 2 V; note 1	40	-	
V <sub>CEsat</sub>	collector-emitter saturation	$I_{C} = 150 \text{ mA}; I_{B} = 15 \text{ mA}; \text{ note } 1$	-	400	mV
voltage	voltage	$I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}; \text{ note } 1$	-	750	mV
V <sub>BEsat</sub> base-emitter saturati	base-emitter saturation voltage	$I_{C} = 150 \text{ mA}; I_{B} = 15 \text{ mA}; \text{ note } 1$	-	950	mV
		$I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}; \text{ note } 1$	-	1.2	V
C <sub>c</sub>	collector capacitance	I <sub>E</sub> =i <sub>e</sub> = 0 A; V <sub>CB</sub> = 5 V; f = 1 MHz	-	8	pF
Ce	emitter capacitance	$I_{C} = i_{c} = 0 \text{ A}; V_{EB} = 500 \text{ mV}; f = 1 \text{ MHz}$	_	30	pF
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 20 mA; V <sub>CE</sub> = 10 V; f =100 MHz	250	-	MHz
Switching t	imes (between 10% and 90% leve	Is); (see Fig.7)			
t <sub>on</sub>	turn-on time	I <sub>Con</sub> = 150 mA; I <sub>Bon</sub> = 15 mA;	_	35	ns
t <sub>d</sub>	delay time	I <sub>Boff</sub> = –15 mA	_	15	ns
t <sub>r</sub>	rise time		_	20	ns
t <sub>off</sub>	turn-off time	]	_	250	ns
t <sub>s</sub>	storage time	]	_	200	ns
t <sub>f</sub>	fall time	]	_	60	ns

Note

1. Pulse test:  $t_p \leq 300~\mu\text{s};~\delta \leq 0.02.$ 

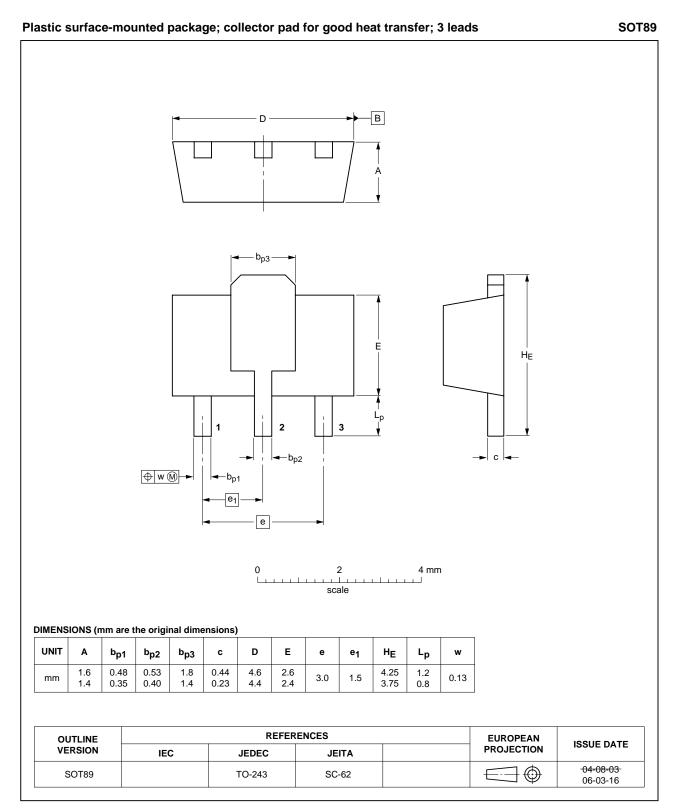




### PXT4401

### PXT4401

#### PACKAGE OUTLINE



2004 Nov 22

PXT4401

#### DATA SHEET STATUS

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

#### Notes

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# **NXP Semiconductors**

#### **Customer notification**

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

#### **Contact information**

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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